

#### **Automotive MOSFET**

#### OptiMOS™ 7 Power-Transistor







#### **Features**

- OptiMOS<sup>™</sup> power MOSFET for automotive applications
- N-channel Enhancement mode Normal Level
- Extended qualification beyond AEC-Q101
- Enhanced electrical testing
- Robust design
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- RoHS compliant
- 100% Avalanche tested

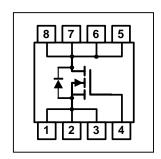
#### **Potential applications**

General automotive applications.

#### **Product validation**

Qualified for automotive applications. Product validation according to AEC-Q101.





#### **Product Summary**

$V_{DS}$	40	V
R <sub>DS(on)</sub>	2.05	mΩ
I <sub>D</sub> (chip limited)	139	Α

Туре	Package	Marking
IAUCN04S7N020	PG-TDSON-8-33	7N04N020

## IAUCN04S7N020



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# **Maximum ratings**

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I <sub>D</sub>	V <sub>GS</sub> =10 V, Chip limitation <sup>1,2)</sup>	139	А
		V <sub>GS</sub> =10V, DC current	120	
		$T_a$ =100 °C, $V_{GS}$ =10 V, $R_{thJA}$ on 2s2p <sup>2,3)</sup>	26	
Pulsed drain current <sup>2)</sup>	I <sub>D,pulse</sub>	$T_{\rm C}$ =25 °C, $t_{\rm p}$ = 100 μs	375	
Avalanche energy, single pulse <sup>2)</sup>	E AS	/ <sub>D</sub> =38 A	55	mJ
Avalanche current, single pulse	I <sub>AS</sub>	-	75	А
Gate source voltage	V <sub>GS</sub>	-	±20	V
Power dissipation	P <sub>tot</sub>	Т <sub>С</sub> =25 °С	75	W
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-	-55 +175	°C

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# Thermal characteristics<sup>2)</sup>

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	]
Thermal resistance, junction - case	R thJC	-	-	1.0	2.0	K/W
Thermal resistance, junction - ambient <sup>3)</sup>	R <sub>thJA</sub>	-	-	28	-	

## **Electrical characteristics**

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Static characteristics						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA	40	-	-	V
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 25 \mu A$	2.2	2.6	3.0	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{\rm DS}$ =40 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	-	-	1	μΑ
		$V_{DS}$ =40 V, $V_{GS}$ =0 V, $T_{j}$ =100 °C <sup>2)</sup>	-	-	6	
Gate-source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	_	-	100	nA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =7 V, I <sub>D</sub> =30 A	-	2.29	2.62	mΩ
		V <sub>GS</sub> =10 V, I <sub>D</sub> =60 A	_	1.85	2.05	
Gate resistance <sup>2)</sup>	R <sub>G</sub>	-	-	2.0	-	Ω

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Parameter	Symbol Conditions		Values			Unit
			min.	typ.	max.	1
Dynamic characteristics <sup>2)</sup>						
Input capacitance	C iss		-	1705	2216	pF
Output capacitance	C oss	$V_{GS}$ =0 V, $V_{DS}$ =20 V, $f$ =1 MHz	_	993	1290	
Reverse transfer capacitance	C <sub>rss</sub>	7	_	36	54	1
Turn-on delay time	t d(on)		_	5	-	ns
Rise time	t <sub>r</sub>	$V_{DD}$ =20 V, $V_{GS}$ =10 V, $I_{D}$ =60 A,	-	2.2	-	- - -
Turn-off delay time	t d(off)	$R_{\rm G}$ =3.5 $\Omega$	_	10	-	
Fall time	t f	1	-	6	-	
Gate to drain charge  Gate charge total	Q gd	$V_{DD}$ =20 V, $I_{D}$ =60 A, $V_{GS}$ =0 to 10 V	-	5 25	8 32	
			-			-
	Q <sub>g</sub>					ļ.,
Gate plateau voltage	$V_{\rm plateau}$		-	4.4	_	V
Reverse Diode					_	_
Diode continous forward current <sup>2)</sup>	Is	<i>T</i> <sub>C</sub> =25 °C	-	-	120	Α
Diode pulse current <sup>2)</sup>	I <sub>S,pulse</sub>	$T_{\rm C}$ =25 °C, $t_{\rm p}$ = 100 $\mu$ s	-	_	375	
Diode forward voltage	V <sub>SD</sub>	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =60 A, $T_{\rm j}$ =25 °C	1	0.8	0.95	V
Reverse recovery time <sup>2)</sup>	t rr	V <sub>R</sub> =20 V, I <sub>F</sub> =50A,	_	24	36	ns
Reverse recovery charge <sup>2)</sup>	Q rr	$di_F/dt = 100 A/\mu s$	-	9	18	nC

<sup>1)</sup> Practically the current is limited by the overall system design including the customer-specific PCB.

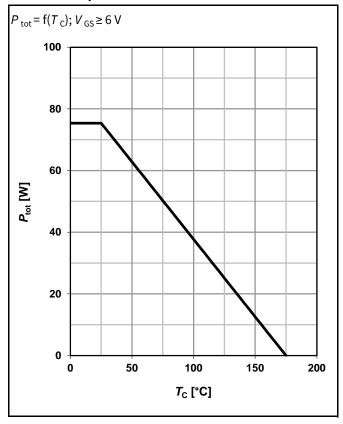
 $<sup>^{2)}\,\</sup>mbox{The parameter}$  is not subject to production testing – specified by design.

<sup>&</sup>lt;sup>3)</sup> Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

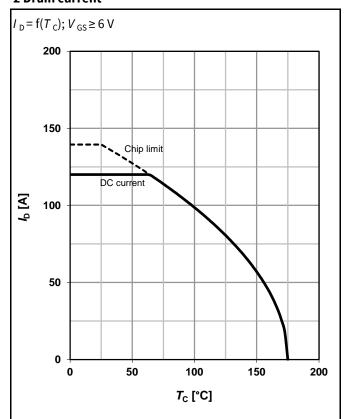


## **Electrical characteristics diagrams**

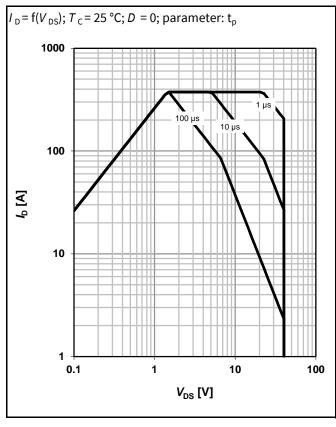
#### 1 Power dissipation



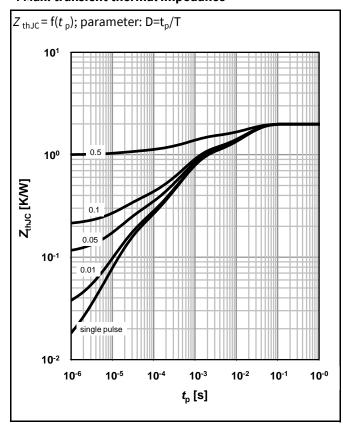
#### 2 Drain current



#### 3 Safe operating area

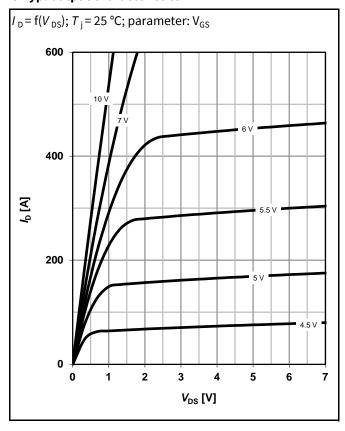


#### 4 Max. transient thermal impedance

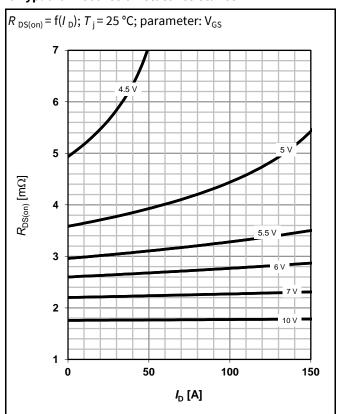




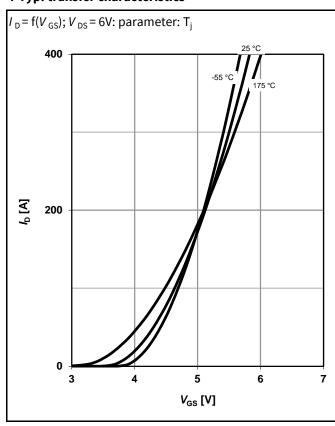
#### 5 Typ. output characteristics



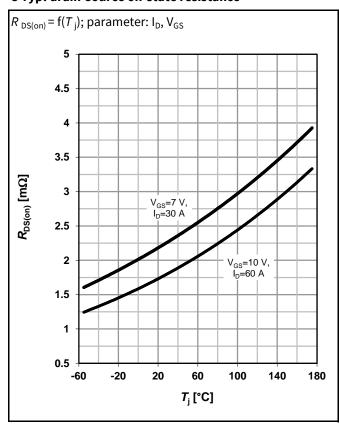
#### 6 Typ. drain-source on-state resistance



#### 7 Typ. transfer characteristics

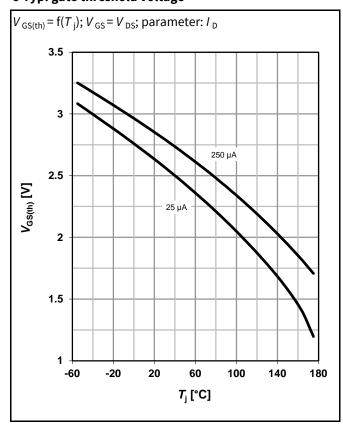


#### 8 Typ. drain-source on-state resistance

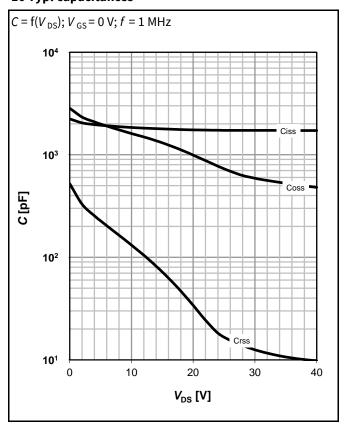


# infineon

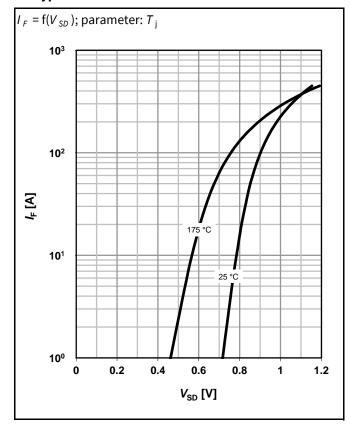
#### 9 Typ. gate threshold voltage



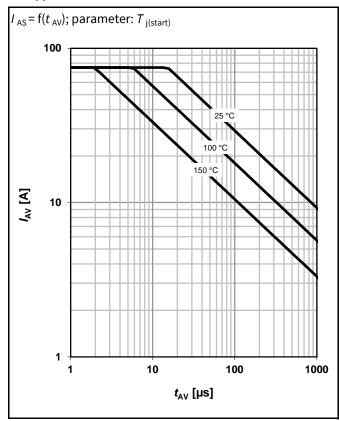
#### 10 Typ. capacitances



#### 11 Typical forward diode characteristics

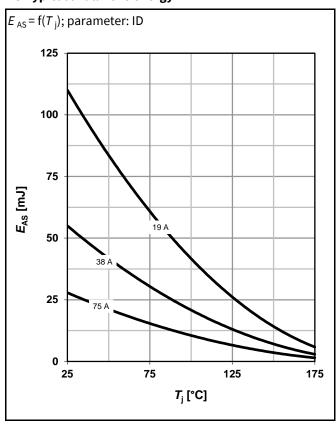


#### 12 Typ. avalanche characteristics

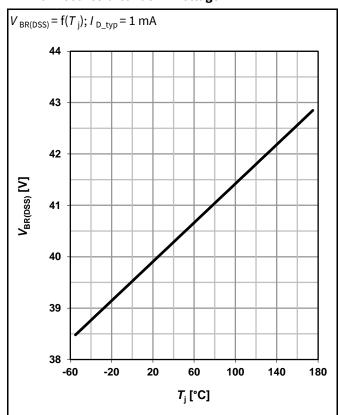


# **(infineon**

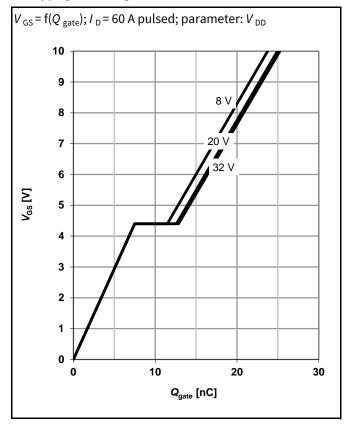
#### 13 Typical avalanche energy



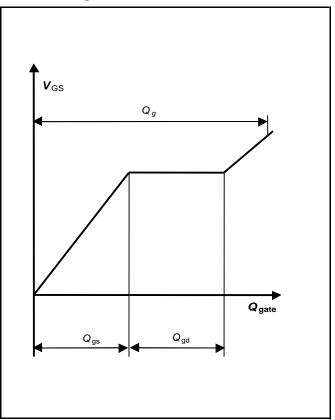
#### 14 Drain-source breakdown voltage



#### 15 Typ. gate charge

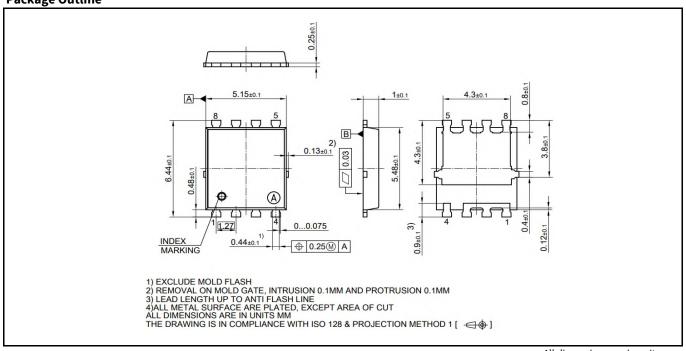


#### 16 Gate charge waveforms



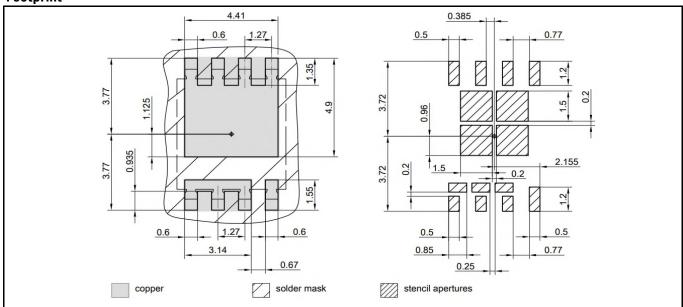


**Package Outline** 



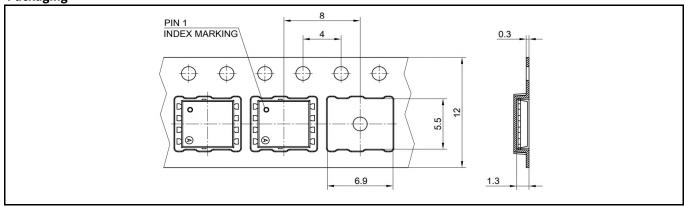
All dimensions are in units mm

#### **Footprint**



All dimensions are in units mm

#### **Packaging**



All dimensions are in units mm

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## **Revision History**

Revision	Date	Changes	
Revision 1.0	15.11.2023	Final Data Sheet	

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